## **IN THE SPECIFICATION:**

Please amend the following paragraph starting at page 24, line 28 as follows:

The tip of the optical fiber 8 is fixed, as inserted in the mounting hole 18 13, to the light-receiving photo-semiconductor device A on its mounting face A.sub.1 (on the face on which the input/output terminal electrode is formed) using the adhesive agent encapsulating resin 5. This configuration permits the tip of the optical fiber 8 to come close to the photo-absorbing layer of the PinPD1 as much as possible, thus preserving a sufficient level of light receiving sensitivity.